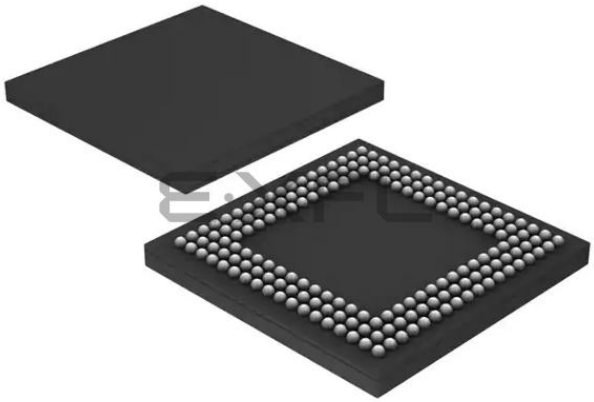

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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	ARM® Cortex®-M4/M0
Core Size	32-Bit Dual-Core
Speed	204MHz
Connectivity	CANbus, EBI/EMI, Ethernet, I²C, IrDA, Microwire, SD, SPI, SSI, SSP, UART/USART, USB, USB OTG
Peripherals	Brown-out Detect/Reset, DMA, I²S, Motor Control PWM, POR, PWM, WDT
Number of I/O	118
Program Memory Size	-
Program Memory Type	ROMless
EEPROM Size	-
RAM Size	264K x 8
Voltage - Supply (Vcc/Vdd)	2.2V ~ 3.6V
Data Converters	A/D 8x10b; D/A 1x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	180-TFBGA
Supplier Device Package	180-TFBGA (12x12)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/lpc4330fet180y

Table 3. Pin description *…continued*

LCD, Ethernet, USB0, and USB1 functions are not available on all parts. See Table 2.

Symbol	LBGA256	TFBGA180	TFBGA100	LQFP144		Reset state [1]	Type	Description
P1_8	R7	M5	H5	51	[2]	N; PU	I/O	**GPIO1[1] —** General purpose digital input/output pin.
							O	**U1_DTR —** Data Terminal Ready output for UART1.
							O	**CTOUT_12 —** SCTimer/PWM output 12. Match output 3 of timer 3.
							I/O	**EMC_D1 —** External memory data line 1.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							O	**SD_VOLT0 —** SD/MMC bus voltage select output 0.
P1_9	T7	N5	J5	52	[2]	N; PU	I/O	**GPIO1[2] —** General purpose digital input/output pin.
							O	**U1_RTS —** Request to Send output for UART1.
							O	**CTOUT_11 —** SCTimer/PWM output 11. Match output 3 of timer 2.
							I/O	**EMC_D2 —** External memory data line 2.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							I/O	**SD_DAT0 —** SD/MMC data bus line 0.
P1_10	R8	N6	H6	53	[2]	N; PU	I/O	**GPIO1[3] —** General purpose digital input/output pin.
							I	**U1_RI —** Ring Indicator input for UART1.
							O	**CTOUT_14 —** SCTimer/PWM output 14. Match output 2 of timer 3.
							I/O	**EMC_D3 —** External memory data line 3.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							I/O	**SD_DAT1 —** SD/MMC data bus line 1.
P1_11	T9	P8	J7	55	[2]	N; PU	I/O	**GPIO1[4] —** General purpose digital input/output pin.
							I	**U1_CTS —** Clear to Send input for UART1.
							O	**CTOUT_15 —** SCTimer/PWM output 15. Match output 3 of timer 3.
							I/O	**EMC_D4 —** External memory data line 4.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							I/O	**SD_DAT2 —** SD/MMC data bus line 2.

Table 3. Pin description *…continued*

LCD, Ethernet, USB0, and USB1 functions are not available on all parts. See Table 2.

Symbol	LBGA256	TFBGA180	TFBGA100	LQFP144		Reset state [1]	Type	Description
P1_16	M7	L5	H9	64	[2]	N; PU	I/O	**GPIO0[3] —** General purpose digital input/output pin.
							I	**U2_RXD —** Receiver input for USART2.
							I/O	**SGPIO3 —** General purpose digital input/output pin.
							I	**ENET_CRS —** Ethernet Carrier Sense (MII interface).
							O	**T0_MAT0 —** Match output 0 of timer 0.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							I	**ENET_RX_DV —** Ethernet Receive Data Valid (RMII/MII interface).
P1_17	M8	L6	H10	66	[3]	N; PU	I/O	**GPIO0[12] —** General purpose digital input/output pin.
							I/O	**U2_UCLK —** Serial clock input/output for USART2 in synchronous mode.
							-	**R —** Function reserved.
							I/O	**ENET_MDIO —** Ethernet MIIM data input and output.
							I	**T0_CAP3 —** Capture input 3 of timer 0.
							O	**CAN1_TD —** CAN1 transmitter output.
							I/O	**SGPIO11 —** General purpose digital input/output pin.
							-	**R —** Function reserved.
P1_18	N12	N10	J10	67	[2]	N; PU	I/O	**GPIO0[13] —** General purpose digital input/output pin.
							I/O	**U2_DIR —** RS-485/EIA-485 output enable/direction control for USART2.
							-	**R —** Function reserved.
							O	**ENET_TXD0 —** Ethernet transmit data 0 (RMII/MII interface).
							O	**T0_MAT3 —** Match output 3 of timer 0.
							I	**CAN1_RD —** CAN1 receiver input.
							I/O	**SGPIO12 —** General purpose digital input/output pin.
							-	**R —** Function reserved.
P1_19	M11	N9	K9	68	[2]	N; PU	I	**ENET_TX_CLK (ENET_REF_CLK) —** Ethernet Transmit Clock (MII interface) or Ethernet Reference Clock (RMII interface).
							I/O	**SSP1_SCK —** Serial clock for SSP1.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							O	**CLKOUT —** Clock output pin.
							-	**R —** Function reserved.
							O	**I2S0_RX_MCLK —** I2S receive master clock.
							I/O	**I2S1_TX_SCK —** Transmit Clock. It is driven by the master and received by the slave. Corresponds to the signal SCK in the I^2S-bus specification.

Table 3. Pin description *…continued*

LCD, Ethernet, USB0, and USB1 functions are not available on all parts. See Table 2.

Symbol	LBGA256	TFBGA180	TFBGA100	LQFP144		Reset state [1]	Type	Description
P2_8	J16	H14	C6	98	[2]	N; PU	I/O	**SGPIO15 —** General purpose digital input/output pin. Boot pin (see Table 5).
							O	**CTOUT_0 —** SCTimer/PWM output 0. Match output 0 of timer 0.
							I/O	**U3_DIR —** RS-485/EIA-485 output enable/direction control for USART3.
							I/O	**EMC_A8 —** External memory address line 8.
							I/O	**GPIO5[7] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
P2_9	H16	G14	B10	102	[2]	N; PU	I/O	**GPIO1[10] —** General purpose digital input/output pin. Boot pin (see Table 5.
							O	**CTOUT_3 —** SCTimer/PWM output 3. Match output 3 of timer 0.
							I/O	**U3_BAUD —** Baud pin for USART3.
							I/O	**EMC_A0 —** External memory address line 0.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
P2_10	G16	F14	E8	104	[2]	N; PU	I/O	**GPIO0[14] —** General purpose digital input/output pin.
							O	**CTOUT_2 —** SCTimer/PWM output 2. Match output 2 of timer 0.
							O	**U2_TXD —** Transmitter output for USART2.
							I/O	**EMC_A1 —** External memory address line 1.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
P2_11	F16	E13	A9	105	[2]	N; PU	I/O	**GPIO1[11] —** General purpose digital input/output pin.
							O	**CTOUT_5 —** SCTimer/PWM output 5. Match output 3 of timer 3.
							I	**U2_RXD —** Receiver input for USART2.
							I/O	**EMC_A2 —** External memory address line 2.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.

Table 3. Pin description *…continued*

LCD, Ethernet, USB0, and USB1 functions are not available on all parts. See Table 2.

Symbol	LBGA256	TFBGA180	TFBGA100	LQFP144		Reset state [1]	Type	Description
PB_6	A6	C5	-	-	[5]	N; PU	-	**R —** Function reserved.
							I/O	**USB1_ULPI_D3 —** ULPI link bidirectional data line 3.
							O	**LCD_VD13 —** LCD data.
							-	**R —** Function reserved.
							I/O	**GPIO5[26] —** General purpose digital input/output pin.
							I	**CTIN_6 —** SCTimer/PWM input 6. Capture input 1 of timer 3.
							O	**LCD_VD19 —** LCD data.
							-	**R —** Function reserved.
							AI	**ADC0_6 —** ADC0 and ADC1, input channel 6. Configure the pin as GPIO input and use the ADC function select register in the SCU to select the ADC.
PC_0	D4	-	-	-	[5]	N; PU	-	**R —** Function reserved.
							I	**USB1_ULPI_CLK —** ULPI link CLK signal. 60 MHz clock generated by the PHY.
							-	**R —** Function reserved.
							I/O	**ENET_RX_CLK —** Ethernet Receive Clock (MII interface).
							O	**LCD_DCLK —** LCD panel clock.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							I/O	**SD_CLK —** SD/MMC card clock.
							AI	**ADC1_1 —** ADC1 and ADC0, input channel 1. Configure the pin as input (USB_ULPI_CLK) and use the ADC function select register in the SCU to select the ADC.
PC_1	E4	-	-	-	[2]	N; PU	I/O	**USB1_ULPI_D7 —** ULPI link bidirectional data line 7.
							-	**R —** Function reserved.
							I	**U1_RI —** Ring Indicator input for UART 1.
							O	**ENET_MDC —** Ethernet MIIM clock.
							I/O	**GPIO6[0] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							I	**T3_CAP0 —** Capture input 0 of timer 3.
							O	**SD_VOLT0 —** SD/MMC bus voltage select output 0.
PC_2	F6	-	-	-	[2]	N; PU	I/O	**USB1_ULPI_D6 —** ULPI link bidirectional data line 6.
							-	**R —** Function reserved.
							I	**U1_CTS —** Clear to Send input for UART 1.
							O	**ENET_TXD2 —** Ethernet transmit data 2 (MII interface).
							I/O	**GPIO6[1] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							O	**SD_RST —** SD/MMC reset signal for MMC4.4 card.

Table 3. Pin description *…continued*

LCD, Ethernet, USB0, and USB1 functions are not available on all parts. See Table 2.

Symbol	LBGA256	TFBGA180	TFBGA100	LQFP144		Reset state [1]	Type	Description
VSSIO	C4, D13, G6, G7, G8, H8, H9, J8, J9, K9, K10, M13, P7, P13	-	C8, D4, D5, G8, J3, J6	4, 40, 76, 109	[13] [14]	-	-	Ground.
VSSA	B2	A3	C2	135		-	-	Analog ground.
Not connected								
-	B9	B8	-	-		-	-	n.c.

[1] N = neutral, input buffer disabled; no extra VDDIO current consumption if the input is driven midway between supplies; set the EZI bit in the SFS register to enable the input buffer; I = input; OL = output driving LOW; OH = output driving HIGH; AI/O = analog input/output; IA = inactive; PU = pull-up enabled (weak pull-up resistor pulls up pin to VDDIO; F = floating. Reset state reflects the pin state at reset without boot code operation.

[2] 5 V tolerant pad with 15 ns glitch filter (5 V tolerant if VDDIO present; if VDDIO not present, do not exceed 3.6 V); provides digital I/O functions with TTL levels and hysteresis; normal drive strength.

[3] 5 V tolerant pad with 15 ns glitch filter (5 V tolerant if VDDIO present; if VDDIO not present, do not exceed 3.6 V); provides digital I/O functions with TTL levels, and hysteresis; high drive strength.

[4] 5 V tolerant pad with 15 ns glitch filter (5 V tolerant if VDDIO present; if VDDIO not present, do not exceed 3.6 V); provides high-speed digital I/O functions with TTL levels and hysteresis.

[5] 5 V tolerant pad providing digital I/O functions (with TTL levels and hysteresis) and analog input or output (5 V tolerant if VDDIO present; if VDDIO not present, do not exceed 3.6 V). When configured as an ADC input or DAC output, the pin is not 5 V tolerant and the digital section of the pad must be disabled by setting the pin to an input function and disabling the pull-up resistor through the pin's SFSP register.

[6] 5 V tolerant transparent analog pad.

[7] For maximum load C_L = 6.5 µF and maximum pull-down resistance R_{pd} = 80 kΩ, the VBUS signal takes about 2 s to fall from VBUS = 5 V to VBUS = 0.2 V when it is no longer driven.

[8] Transparent analog pad. Not 5 V tolerant.

[9] Pad provides USB functions 5 V tolerant if VDDIO present; if VDDIO not present, do not exceed 3.6 V. It is designed in accordance with the USB specification, revision 2.0 (Full-speed and Low-speed mode only).

[10] Open-drain 5 V tolerant digital I/O pad, compatible with I2C-bus Fast Mode Plus specification. This pad requires an external pull-up to provide output functionality. When power is switched off, this pin connected to the I2C-bus is floating and does not disturb the I2C lines.

[11] 5 V tolerant pad with 20 ns glitch filter; provides digital I/O functions with open-drain output and hysteresis.

[12] VPP is internally connected to VDDIO for all packages with the exception of the LBGA256 package.

[13] On the LQFP144 package, VSSIO and VSS are connected to a common ground plane.

[14] On the TFBGA100 package, VSS is internally connected to VSSIO.

7.5 AHB multilayer matrix

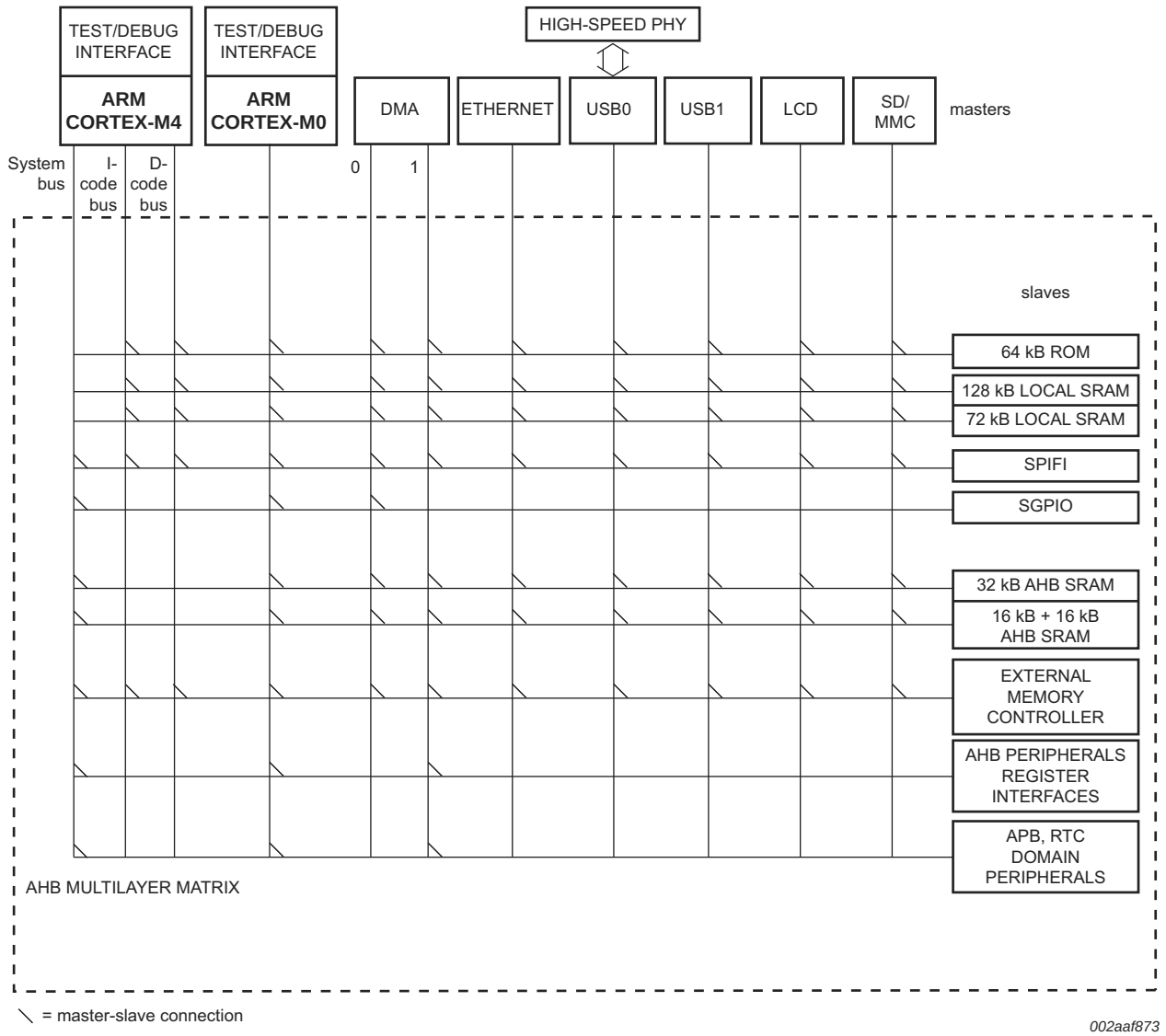


Fig 6. AHB multilayer matrix master and slave connections

7.6 Nested Vectored Interrupt Controller (NVIC)

The NVIC is an integral part of the Cortex-M4. The tight coupling to the CPU allows for low interrupt latency and efficient processing of late arriving interrupts.

The ARM Cortex-M0 co-processor has its own NVIC with 32 vectored interrupts. Most peripheral interrupts are shared between the Cortex-M0 and Cortex-M4 NVICs.

- LCD panel clock may be generated from the peripheral clock, or from a clock input pin.

7.17.8 Ethernet

Remark: The Ethernet peripheral is available on parts LPC4350/30. See Table 2.

7.17.8.1 Features

- 10/100 Mbit/s.
- DMA support.
- Power management remote wake-up frame and magic packet detection.
- Supports both full-duplex and half-duplex operation
  - Supports CSMA/CD Protocol for half-duplex operation.
  - Supports IEEE 802.3x flow control for full-duplex operation.
  - Optional forwarding of received pause control frames to the user application in full-duplex operation.
  - Back-pressure support for half-duplex operation.
  - Automatic transmission of zero-quanta pause frame on deassertion of flow control input in full-duplex operation.
- Supports IEEE1588 time stamping and IEEE 1588 advanced time stamping (IEEE 1588-2008 v2).

7.18 Digital serial peripherals

7.18.1 UART1

The LPC4350/30/20/10 contain one UART with standard transmit and receive data lines. UART1 also provides a full modem control handshake interface and support for RS-485/9-bit mode allowing both software address detection and automatic address detection using 9-bit mode.

UART1 includes a fractional baud rate generator. Standard baud rates such as 115200 Bd can be achieved with any crystal frequency above 2 MHz.

7.18.1.1 Features

- Maximum UART data bit rate of 8 MBit/s.
- 16 B Receive and Transmit FIFOs.
- Register locations conform to 16C550 industry standard.
- Receiver FIFO trigger points at 1 B, 4 B, 8 B, and 14 B.
- Built-in fractional baud rate generator covering wide range of baud rates without a need for external crystals of particular values.
- Auto baud capabilities and FIFO control mechanism that enables software flow control implementation.
- Equipped with standard modem interface signals. This module also provides full support for hardware flow control.
- Support for RS-485/9-bit/EIA-485 mode (UART1).

The I²S-bus provides a standard communication interface for digital audio applications.

The *I²S-bus specification* defines a 3-wire serial bus using one data line, one clock line, and one word select signal. The basic I²S-bus connection has one master, which is always the master, and one slave. The I²S-bus interface provides a separate transmit and receive channel, each of which can operate as either a master or a slave.

7.18.6.1 Features

- The I²S interface has separate input/output channels, each of which can operate in master or slave mode.
- Capable of handling 8-bit, 16-bit, and 32-bit word sizes.
- Mono and stereo audio data supported.
- The sampling frequency can range from 16 kHz to 192 kHz (16, 22.05, 32, 44.1, 48, 96, 192) kHz.
- Support for an audio master clock.
- Configurable word select period in master mode (separately for I²S-bus input and output).
- Two 8-word FIFO data buffers are provided, one for transmit and one for receive.
- Generates interrupt requests when buffer levels cross a programmable boundary.
- Two DMA requests controlled by programmable buffer levels. The DMA requests are connected to the GPDMA block.
- Controls include reset, stop and mute options separately for I²S-bus input and I²S-bus output.

7.18.7 C_CAN

Remark: The LPC4350/30/20/10 contain two C_CAN controllers.

Controller Area Network (CAN) is the definition of a high performance communication protocol for serial data communication. The C_CAN controller is designed to provide a full implementation of the CAN protocol according to the CAN Specification Version 2.0B. The C_CAN controller can create powerful local networks with low-cost multiplex wiring by supporting distributed real-time control with a high level of reliability.

7.18.7.1 Features

- Conforms to protocol version 2.0 parts A and B.
- Supports bit rate of up to 1 Mbit/s.
- Supports 32 Message Objects.
- Each Message Object has its own identifier mask.
- Provides programmable FIFO mode (concatenation of Message Objects).
- Provides maskable interrupts.
- Supports Disabled Automatic Retransmission (DAR) mode for time-triggered CAN applications.
- Provides programmable loop-back mode for self-test operation.

- Increments/decrements depending on direction.
- Programmable for 2× or 4× position counting.
- Velocity capture using built-in timer.
- Velocity compare function with “less than” interrupt.
- Uses 32-bit registers for position and velocity.
- Three position-compare registers with interrupts.
- Index counter for revolution counting.
- Index compare register with interrupts.
- Can combine index and position interrupts to produce an interrupt for whole and partial revolution displacement.
- Digital filter with programmable delays for encoder input signals.
- Can accept decoded signal inputs (clk and direction).

7.19.4 Repetitive Interrupt (RI) timer

The repetitive interrupt timer provides a free-running 32-bit counter which is compared to a selectable value, generating an interrupt when a match occurs. Any bits of the timer/compare function can be masked such that they do not contribute to the match detection. The repetitive interrupt timer can be used to create an interrupt that repeats at predetermined intervals.

7.19.4.1 Features

- 32-bit counter. Counter can be free-running or be reset by a generated interrupt.
- 32-bit compare value.
- 32-bit compare mask. An interrupt is generated when the counter value equals the compare value, after masking. This mechanism allows for combinations not possible with a simple compare.

7.19.5 Windowed WatchDog Timer (WWDT)

The purpose of the watchdog is to reset the controller if software fails to periodically service it within a programmable time window.

7.19.5.1 Features

- Internally resets chip if not periodically reloaded during the programmable time-out period.
- Optional windowed operation requires reload to occur between a minimum and maximum time period, both programmable.
- Optional warning interrupt can be generated at a programmable time prior to watchdog time-out.
- Enabled by software but requires a hardware reset or a watchdog reset/interrupt to be disabled.
- Incorrect feed sequence causes reset or interrupt if enabled.
- Flag to indicate watchdog reset.
- Programmable 24-bit timer with internal prescaler.

7.22.4 Internal RC oscillator (IRC)

The IRC is used as the clock source for the WWDT and/or as the clock that drives the PLLs and the CPU. The nominal IRC frequency is 12 MHz. The IRC is trimmed to 1.5 % accuracy over the entire voltage and temperature range.

Upon power-up or any chip reset, the LPC4350/30/20/10 use the IRC as the clock source. The boot loader then configures the PLL1 to provide a 96 MHz clock for the core and the PLL0USB or PLL0AUDIO as needed if an external boot source is selected.

7.22.5 PLL0USB (for USB0)

PLL0 is a dedicated PLL for the USB0 High-speed controller.

PLL0 accepts an input clock frequency from an external oscillator in the range of 14 kHz to 25 MHz. The input frequency is multiplied up to a high frequency with a Current Controlled Oscillator (CCO). The CCO operates in the range of 4.3 MHz to 550 MHz.

7.22.6 PLL0AUDIO (for audio)

The audio PLL PLL0AUDIO is a general-purpose PLL with a small step size. This PLL accepts an input clock frequency derived from an external oscillator or internal IRC. The input frequency is multiplied up to a high frequency with a Current Controlled Oscillator (CCO). A sigma-delta converter modulates the PLL divider ratios to obtain the desired output frequency. The output frequency can be set as a multiple of the sampling frequency f_s to $32 \times f_s$, $64 \times f_s$, $128 \times f_s$, $256 \times f_s$, $384 \times f_s$, $512 \times f_s$ and the sampling frequency f_s can range from 16 kHz to 192 kHz (16, 22.05, 32, 44.1, 48, 96,192) kHz. Many other frequencies are possible as well using the integrated fractional divider.

7.22.7 System PLL1

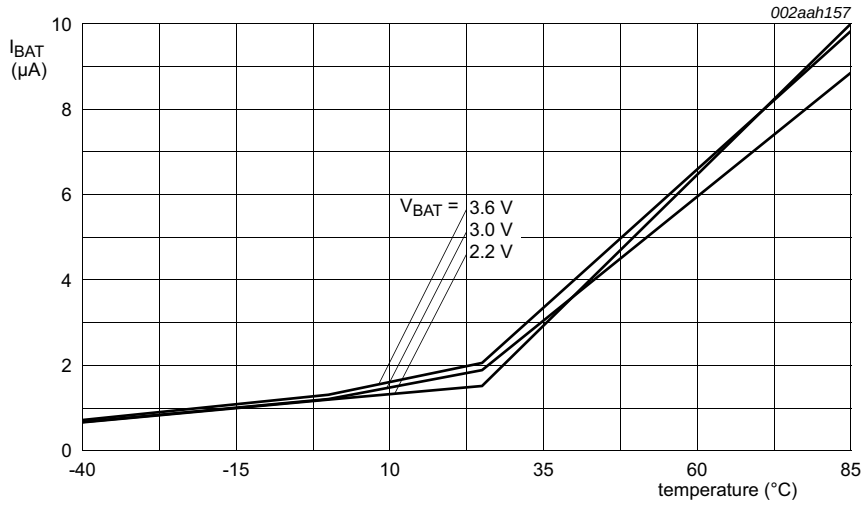
The PLL1 accepts an input clock frequency from an external oscillator in the range of 1 MHz to 25 MHz. The input frequency is multiplied up to a high frequency with a Current Controlled Oscillator (CCO). The multiplier can be an integer value from 1 to 32. The CCO operates in the range of 156 MHz to 320 MHz. This range is possible through an additional divider in the loop to keep the CCO within its frequency range while the PLL is providing the desired output frequency. The output divider can be set to divide by 2, 4, 8, or 16 to produce the output clock. Since the minimum output divider value is 2, it is insured that the PLL output has a 50 % duty cycle. The PLL is turned off and bypassed following a chip reset. After reset, software can enable the PLL. The program must configure and activate the PLL, wait for the PLL to lock, and then connect to the PLL as a clock source. The PLL settling time is 100 μs.

7.22.8 Reset Generation Unit (RGU)

The RGU allows generation of independent reset signals for individual blocks and peripherals on the LPC4350/30/20/10.

7.22.9 Power control

The LPC4350/30/20/10 feature several independent power domains to control power to the core and the peripherals (see Figure 9). The RTC and its associated peripherals (the alarm timer, the CREG block, the OTP controller, the back-up registers, and the event router) are located in the RTC power-domain. The main regulator or a battery supply can power the RTC. A power selector switch ensures that the RTC block is always powered on.



Conditions: $V_{DD(REG)(3V3)}$, $V_{DD(IO)}$ floating.

Fig 19. Typical battery supply versus temperature in Deep power-down mode

10.2 Peripheral power consumption

The typical power consumption at T = 25 °C for each individual peripheral is measured as follows:

1. Enable all branch clocks and measure the current $I_{DD(REG)(3V3)}$.
2. Disable the branch clock to the peripheral to be measured and keep all other branch clocks enabled.
3. Calculate the difference between measurement 1 and 2. The result is the peripheral power consumption.

Table 11. Peripheral power consumption

Peripheral	Branch clock	$I_{DD(REG)(3V3)}$ in mA	
		Branch clock frequency = 48 MHz	Branch clock frequency = 96 MHz
M0 core	CLK_M4_M0APP	3.3	6.6
I2C1	CLK_APB3_I2C1	0.01	0.02
I2C0	CLK_APB1_I2C0	0.02	0.01
DAC	CLK_APB3_DAC	0.01	0.02
ADC0	CLK_APB3_ADC0	0.05	0.05
ADC1	CLK_APB3_ADC1	0.04	0.04
CAN0	CLK_APB3_CAN0	0.17	0.17
CAN1	CLK_APB1_CAN1	0.17	0.17
MOTOCON	CLK_APB1_MOTOCON	0.05	0.05
I2S	CLK_APB1_I2S	0.11	0.11
SPIFI	CLK_SPIFI, CLK_M4_SPIFI	0.95	1.85
GPIO	CLK_M4_GPIO	0.66	1.31

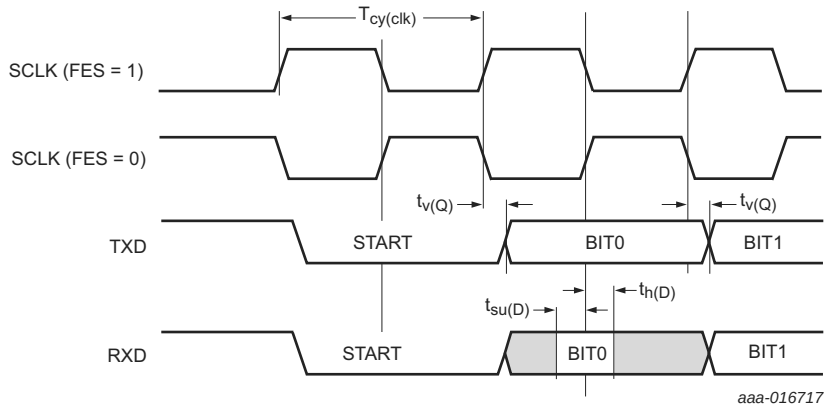


Fig 30. USART timing

11.11 SSP interface

Table 24. Dynamic characteristics: SSP pins in SPI mode

T_{amb} = −40 °C to +85 °C; 2.2 V ≤ $V_{DD(REG)(3V3)}$ ≤ 3.6 V; 2.7 V ≤ $V_{DD(IO)}$ ≤ 3.6 V; C_L = 20 pF. Sampled at 10 % and 90 % of the signal level; EHS = 1 for all pins. Simulated values.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
SSP master							
$T_{cy(clk)}$	clock cycle time	full-duplex mode	[1]	$1/(25.5 \times 10^6)$	-	-	s
		when only transmitting		$1/(51 \times 10^6)$	-	-	s
t_{DS}	data set-up time	in SPI mode		13.6	-	-	ns
t_{DH}	data hold time	in SPI mode		−3.8	-	-	ns
$t_{v(Q)}$	data output valid time	in SPI mode		-	-	6.0	ns
$t_{h(Q)}$	data output hold time	in SPI mode		−1.1	-	-	ns
t_{lead}	lead time	continuous transfer mode SPI mode; CPOL = 0; CPHA = 0		$T_{cy(clk)} + 3.2$	-	$T_{cy(clk)} + 6.1$	ns
		SPI mode; CPOL = 0; CPHA = 1		$0.5 \times T_{cy(clk)} + 3.2$	-	$0.5 \times T_{cy(clk)} + 6.1$	ns
		SPI mode; CPOL = 1; CPHA = 0		$T_{cy(clk)} + 3.2$	-	$T_{cy(clk)} + 6.1$	ns
		SPI mode; CPOL = 1; CPHA = 1		$0.5 \times T_{cy(clk)} + 3.2$	-	$0.5 \times T_{cy(clk)} + 6.1$	ns
		synchronous serial frame mode		$0.5 \times T_{cy(clk)} + 3.2$	-	$0.5 \times T_{cy(clk)} + 6.1$	ns
		microwire frame format		$T_{cy(clk)} + 3.2$	-	$T_{cy(clk)} + 6.1$	ns
t_{lag}	lag time	continuous transfer mode SPI mode; CPOL = 0; CPHA = 0		$0.5 \times T_{cy(clk)}$	-	-	ns
		SPI mode; CPOL = 0; CPHA = 1		$T_{cy(clk)}$	-	-	ns
		SPI mode; CPOL = 1; CPHA = 0		$0.5 \times T_{cy(clk)}$	-	-	ns
		SPI mode; CPOL = 1; CPHA = 1		$T_{cy(clk)}$	-	-	ns
		synchronous serial frame mode		$T_{cy(clk)}$	-	-	ns
		microwire frame format		$0.5 \times T_{cy(clk)}$	-	-	ns

Table 27. Dynamic characteristics: Static asynchronous external memory interface *…continued*

C_L = 22 pF for EMC_Dn C_L = 20 pF for all others; T_{amb} = −40 °C to +85 °C; 2.2 V ≤ $V_{DD(REG)(3V3)}$ ≤ 3.6 V; 2.7 V ≤ $V_{DD(IO)}$ ≤ 3.6 V; values guaranteed by design; the values in the table have been calculated with WAITTURN = 0x0 in STATICWAITTURN register. Timing parameters are given for single memory access cycles. In a normal read operation, the EMC changes the address while CS is asserted resulting in multiple memory accesses.

Symbol	Parameter[1]	Conditions		Min	Typ	Max	Unit
$t_{BLSLBLSH}$	$\overline{BLS}$ LOW to $\overline{BLS}$ HIGH time	PB = 0	[2]	−0.9 + (WAITWR − WAITWEN + 1) × $T_{cy(clk)}$	-	−0.1 + (WAITWR − WAITWEN + 1) × $T_{cy(clk)}$	ns
$t_{BLSHEOW}$	$\overline{BLS}$ HIGH to end of write time	PB = 0	[2] [5]	−1.9 + $T_{cy(clk)}$	-	−0.5 + $T_{cy(clk)}$	ns
$t_{BLSHDNV}$	$\overline{BLS}$ HIGH to data invalid time	PB = 0	[1] [2]	−2.5 + $T_{cy(clk)}$	-	1.4 + $T_{cy(clk)}$	ns
t_{CSHEOW}	$\overline{CS}$ HIGH to end of write time		[5]	−2.0	-	0	ns
$t_{BLSHDNV}$	$\overline{BLS}$ HIGH to data invalid time	PB = 1		−2.5	-	1.4	ns
t_{WEHANV}	WE HIGH to address invalid time	PB = 1		−0.9 + $T_{cy(clk)}$	-	2.4 + $T_{cy(clk)}$	ns

[1] Parameters specified for 40 % of $V_{DD(IO)}$ for rising edges and 60 % of $V_{DD(IO)}$ for falling edges.

[2] $T_{cy(clk)}$ = 1/CCLK (see LPC43xx User manual).

[3] End Of Read (EOR): longest of t_{CSHOEH}, t_{OEHANV}, $t_{CSHBLSH}$.

[4] Start Of Read (SOR): longest of t_{CSLAV}, t_{CSLOEL}, $t_{CSLBLSL}$.

[5] End Of Write (EOW): earliest of address not valid or $\overline{EMC\_BLSn}$ HIGH.

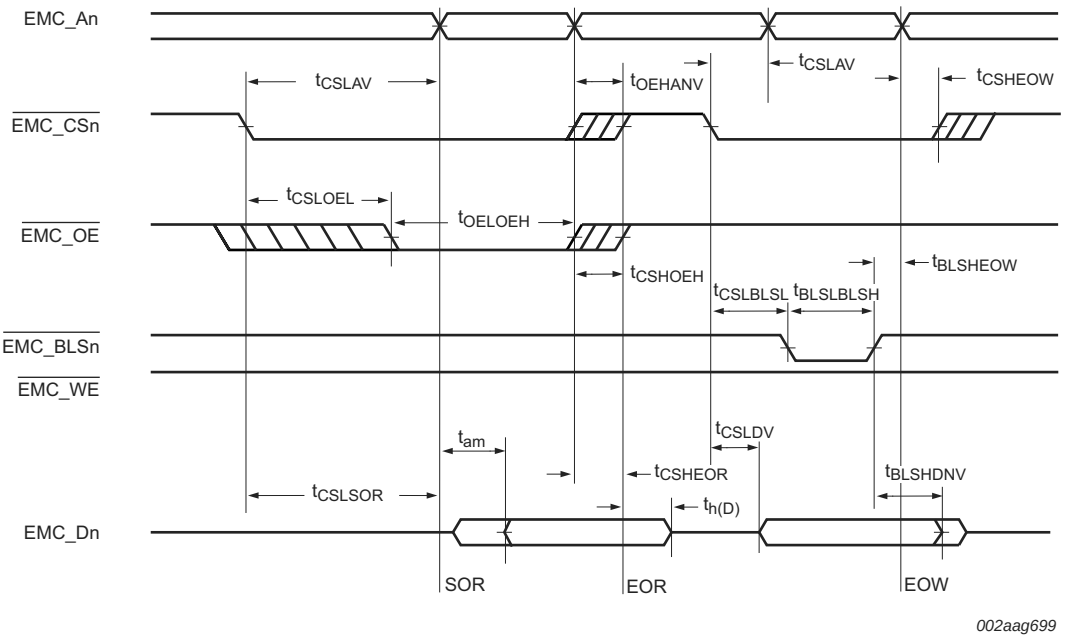


Fig 34. External static memory read/write access (PB = 0)

Table 31. Static characteristics: USB0 PHY pins[1]

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
High-speed mode							
P_{cons}	power consumption		[2]	-	68	-	mW
$I_{DDA(3V3)}$	analog supply current (3.3 V)	on pin USB0_VDDA3V3_DRIVER; total supply current	[3]	-	18	-	mA
		during transmit		-	31	-	mA
		during receive		-	14	-	mA
		with driver tri-stated		-	14	-	mA
I_{DDD}	digital supply current			-	7	-	mA
Full-speed/low-speed mode							
P_{cons}	power consumption		[2]	-	15	-	mW
$I_{DDA(3V3)}$	analog supply current (3.3 V)	on pin USB0_VDDA3V3_DRIVER; total supply current		-	3.5	-	mA
		during transmit		-	5	-	mA
		during receive		-	3	-	mA
		with driver tri-stated		-	3	-	mA
I_{DDD}	digital supply current			-	3	-	mA
Suspend mode							
$I_{DDA(3V3)}$	analog supply current (3.3 V)			-	24	-	μA
		with driver tri-stated		-	24	-	μA
		with OTG functionality enabled		-	3	-	mA
I_{DDD}	digital supply current			-	30	-	μA
VBUS detector outputs							
V_{th}	threshold voltage	for VBUS valid		4.4	-	-	V
		for session end		0.2	-	0.8	V
		for A valid		0.8	-	2	V
		for B valid		2	-	4	V
V_{hys}	hysteresis voltage	for session end		-	150	10	mV
		A valid		-	200	10	mV
		B valid		-	200	10	mV

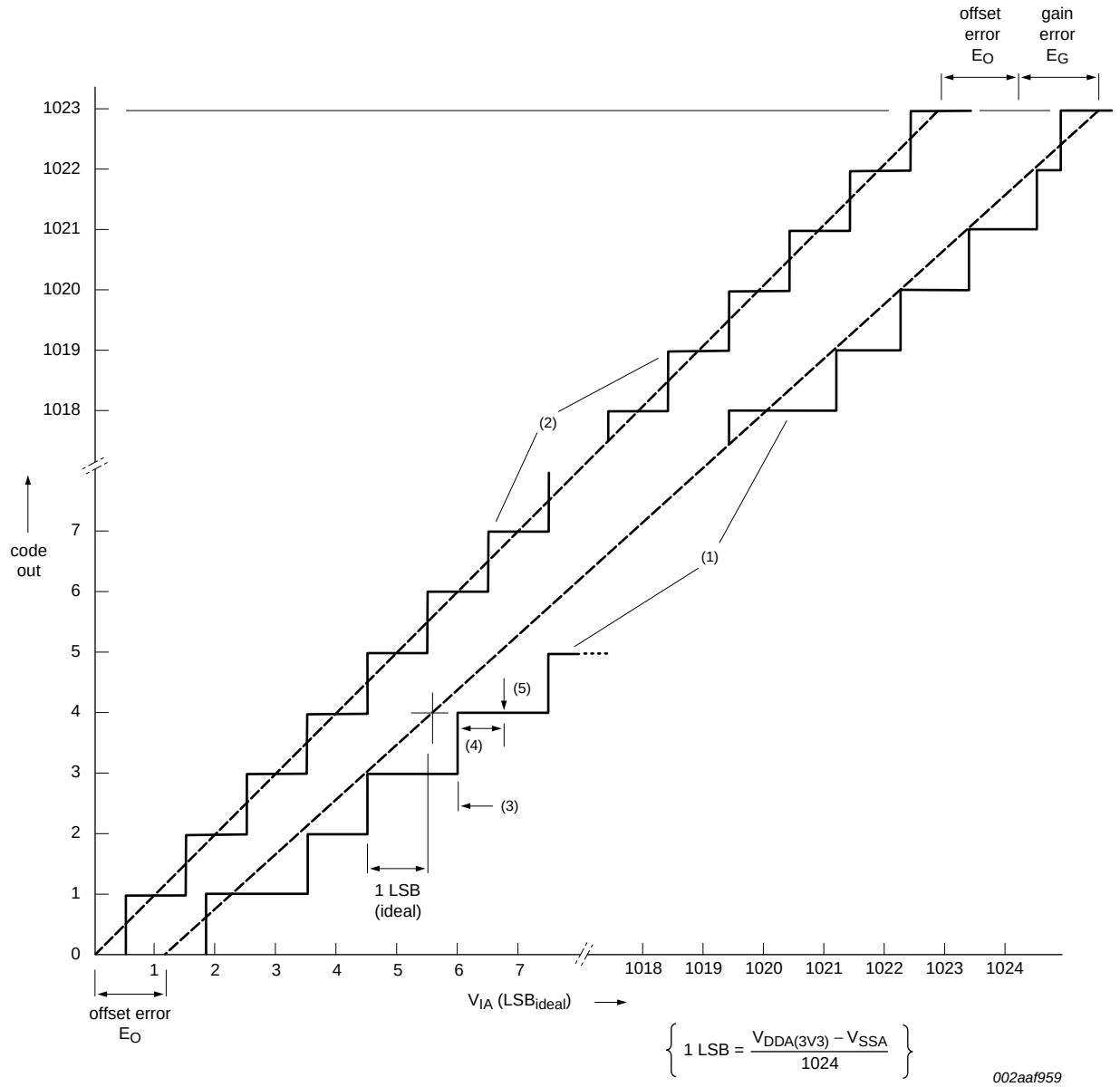
[1] Characterized but not implemented as production test.

[2] Total average power consumption.

[3] The driver is active only 20 % of the time.

11.17 Ethernet

Remark: The timing characteristics of the ENET_MDC and ENET_MDIO signals comply with the *IEEE standard 802.3*.



(1) Example of an actual transfer curve.

(2) The ideal transfer curve.

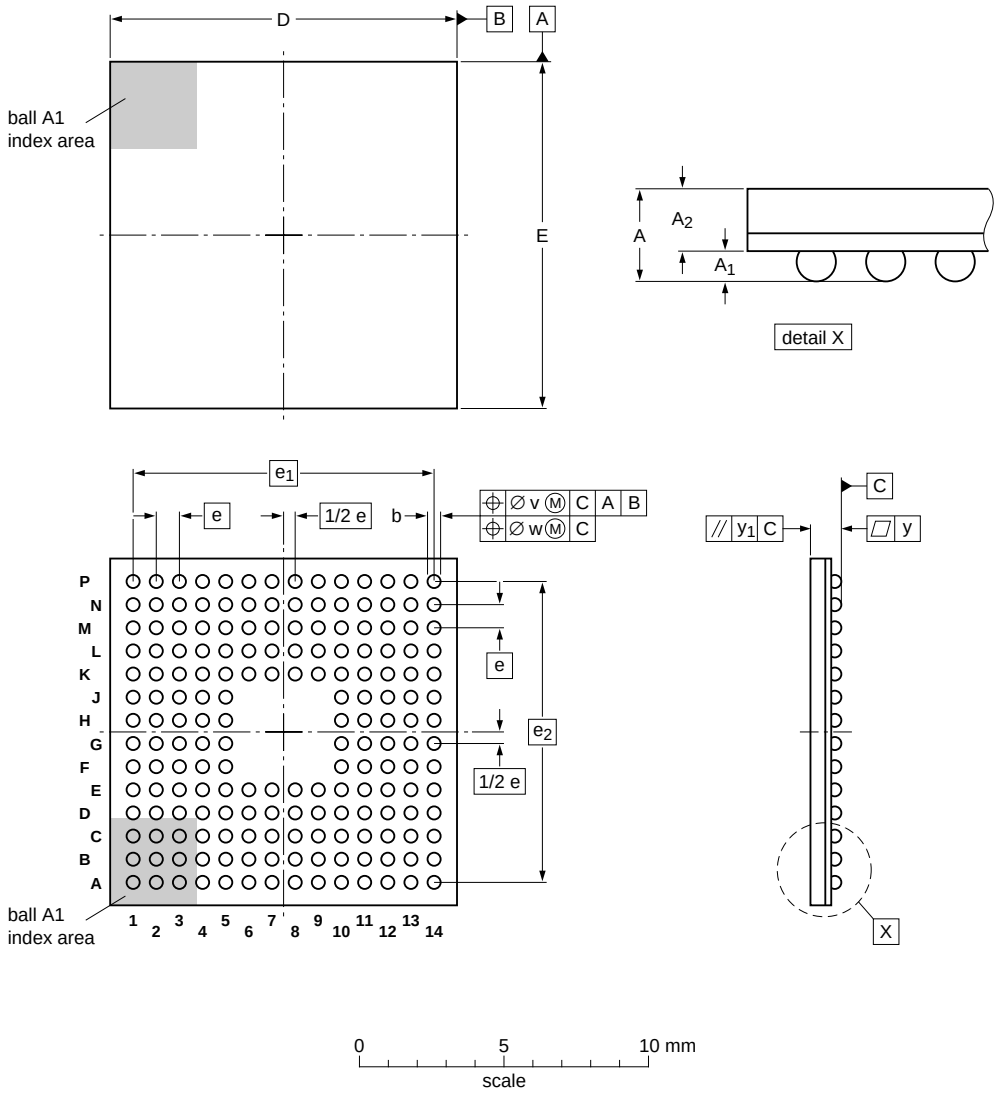
(3) Differential linearity error (E_D).

(4) Integral non-linearity ($E_{L(adj)}$).

(5) Center of a step of the actual transfer curve.

Fig 41. 10-bit ADC characteristics

TFBGA180: thin fine-pitch ball grid array package; 180 balls **SOT570-3**



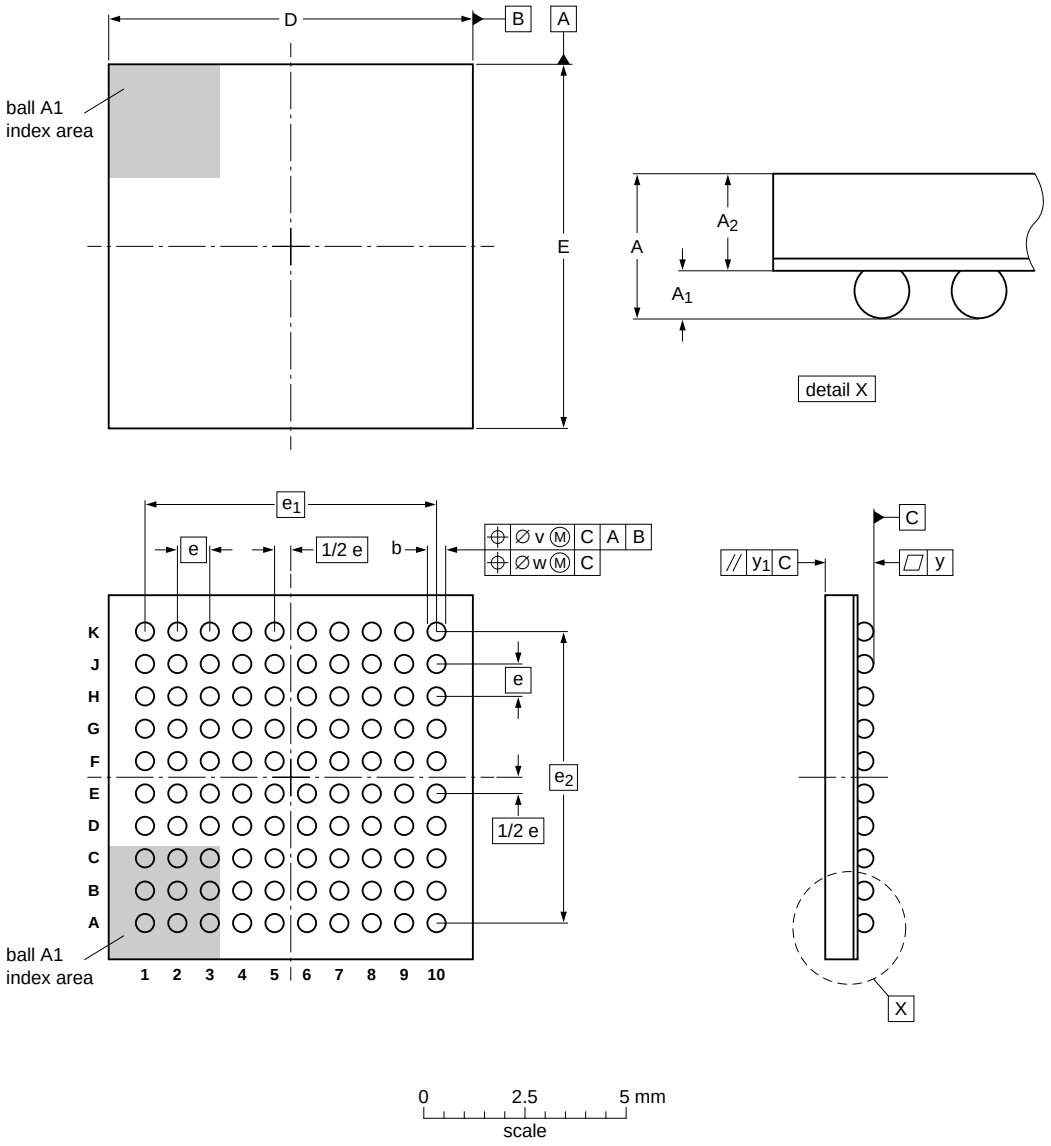
DIMENSIONS (mm are the original dimensions)

UNIT		A	A_1	A_2	b	D	E	e	e_1	e_2	v	w	y	y_1
mm	max	1.20	0.40	0.80	0.50	12.1	12.1	0.8	10.4	10.4	0.15	0.05	0.12	0.1
	nom	1.06	0.35	0.71	0.45	12.0	12.0							
	min	0.95	0.30	0.65	0.40	11.9	11.9							

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT570-3						~~08-07-09~~ 10-04-15

Fig 52. Package outline of the TFBGA180 package

TFBGA100: plastic thin fine-pitch ball grid array package; 100 balls; body 9 x 9 x 0.7 mm **SOT926-1**



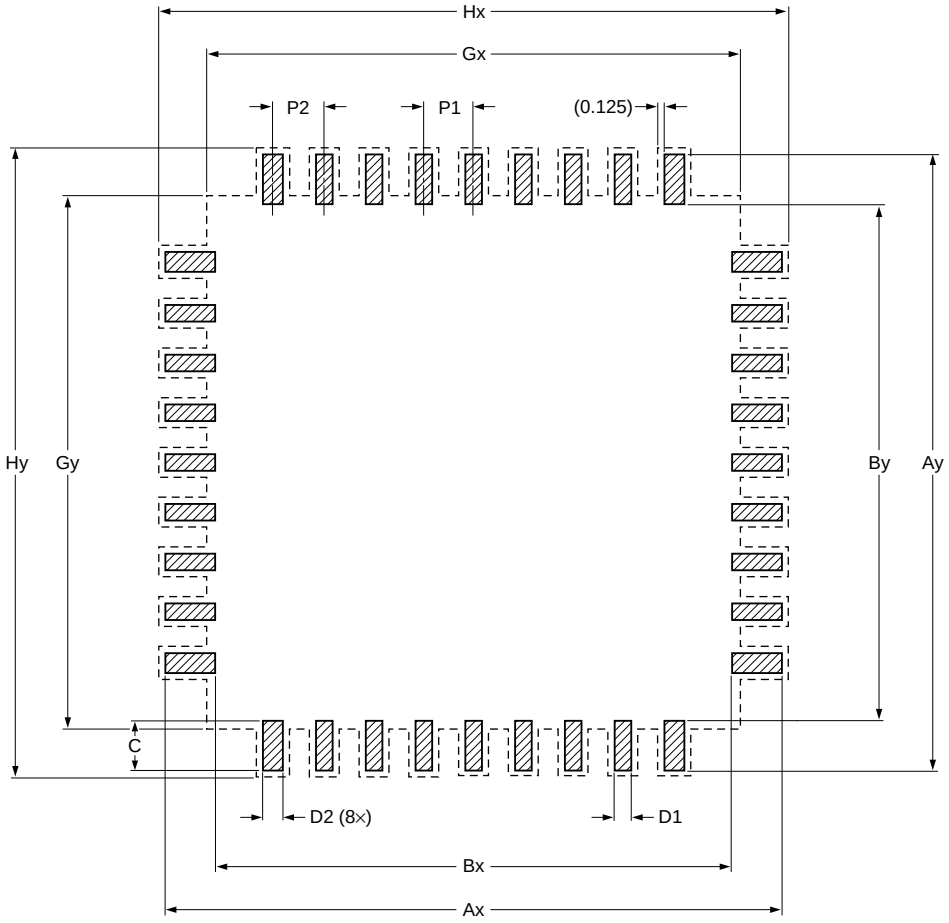
DIMENSIONS (mm are the original dimensions)

UNIT	A max	A_1	A_2	b	D	E	e	e_1	e_2	v	w	y	y_1
mm	1.2	0.4 0.3	0.8 0.65	0.5 0.4	9.1 8.9	9.1 8.9	0.8	7.2	7.2	0.15	0.05	0.08	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT926-1	- - -	- - -	- - -			~~05-12-09~~ 05-12-22

Fig 53. Package outline of the TFBGA100 package

Footprint information for reflow soldering of LQFP144 package **SOT486-1**



Generic footprint pattern

Refer to the package outline drawing for actual layout

solder land

occupied area

DIMENSIONS in mm

P1	P2	Ax	Ay	Bx	By	C	D1	D2	Gx	Gy	Hx	Hy
0.500	0.560	23.300	23.300	20.300	20.300	1.500	0.280	0.400	20.500	20.500	23.550	23.550

sot486-1_fr

Fig 57. Reflow soldering of the LQFP144 package

16. Abbreviations

Table 43. Abbreviations

Acronym	Description
ADC	Analog-to-Digital Converter
AHB	Advanced High-performance Bus
APB	Advanced Peripheral Bus
API	Application Programming Interface
BOD	BrownOut Detection
CAN	Controller Area Network
CMAC	Cipher-based Message Authentication Code
CSMA/CD	Carrier Sense Multiple Access with Collision Detection
DAC	Digital-to-Analog Converter
DC-DC	Direct Current-to-Direct Current
DMA	Direct Memory Access
GPIO	General-Purpose Input/Output
IRC	Internal RC
IrDA	Infrared Data Association
JTAG	Joint Test Action Group
LCD	Liquid Crystal Display
LSB	Least Significant Bit
MAC	Media Access Control
MCU	MicroController Unit
MIIM	Media Independent Interface Management
n.c.	not connected
OHCI	Open Host Controller Interface
OTG	On-The-Go
PHY	Physical Layer
PLL	Phase-Locked Loop
PMC	Power Mode Control
PWM	Pulse Width Modulator
RIT	Repetitive Interrupt Timer
RMII	Reduced Media Independent Interface
SDRAM	Synchronous Dynamic Random Access Memory
SIMD	Single Instruction Multiple Data
SPI	Serial Peripheral Interface
SSI	Serial Synchronous Interface
SSP	Synchronous Serial Port
UART	Universal Asynchronous Receiver/Transmitter
ULPI	UTMI+ Low Pin Interface
USART	Universal Synchronous Asynchronous Receiver/Transmitter
USB	Universal Serial Bus
UTMI	USB2.0 Transceiver Macrocell Interface